DPI Immunity Modeling of a Low Dropout Voltage Regulator

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Abstract: The susceptibility of a low dropout voltage regulator (LDO) in direct power injection (DPI) is analyzed by measurements and simulation. The measurements highlight the offset in the output induced by the conducted RF disturbances and various failure modes. Discrete components used in the injection path and test board are modeled based on impedance measurements. DPI simulations using simple and complex models are presented, which highlight the strongly non-linear behavior of the circuit even at low levels of power injection. The comparison between measurement and results of different models is given. And the reasons for the diversity of immunity level in frequency domain are analyzed.

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1 Introduction

This application note addresses the immunity of a Low-Dropout (LDO) 5 V regulator and its modeling [1]. Based on impedance and Direct-Power-Injection (DPI) measurements [2], the objective of our work is to propose a simple and accurate model of the regulator and its surrounding discrete components, for further use of printed-circuit-board (PCB) level EMC prediction.

The device under test (DUT) used in our investigations is a low-power regulator designed for supplying microcontrollers in embedded applications, typically automotive electronic sub-systems. The regulator features an output voltage precision around ±1% at 5 V.

Section 2 explains our measurement and modeling flow in general terms. In Section 3 the impedance measurements for discrete on-board devices and for the L4949 are presented. These DPI measurements are exploited in Section 4, where several models are introduced and simulated with increased structural complexity. An efficient non-linear approach for macro modeling is presented, based on the Spice “B-element”.

2 DPI Setup

The DPI measurement setup used in the L4949 study is shown in Fig. 1. It includes the DUT board designed by F. Lafon [4], the EMI injection (Signal generator, amplifier, coupler and power meter), the DC voltage source, on-board bias tees and failure monitoring. The measurement is carried out according to the IEC 62132-4 “DPI” standard [2]. The test setup is controlled by a Labview software.
The program controls the power injected to the DUT, the frequency of the RFI, and the failure criterion.

3 Discrete Component models

The discrete components used in the PCB board for a nominal operation of the L4949 regulator and the DPI injection are characterized by the VNA in order to extract their impedance variation with frequency, within the range [1-3000 MHz]. From these results, models are extracted for each component that may have a direct impact on the DPI measurements and models [3]. The set of components is illustrated in Fig. 3.

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<tr>
<th>Model</th>
<th>Parts</th>
<th>Symbol</th>
<th>Comments</th>
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<tr>
<td></td>
<td>Resistor</td>
<td>R_reset</td>
<td>Reset resistor</td>
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3.1 DPI path model

To model the injection path, we need to take into account the 1-nF capacitance and the 17-mm length PCB track from the SMA conductor to the capacitance. The PCB board includes a specific pattern, shown in fig. 4, which eases the impedance characterization of the injection path.
The model of the injection path is composed of a 34 Ω transmission line and a RLC circuit that models the 1 nF DPI capacitance (Fig. 5). The transmission line do not take into account losses. An alternative is to build a T-model as described below, which includes serial losses (here a 0.1 Ω resistance). Figure 6 shows a good correlation between measurement and simulation of the impedance from 1 MHz to 3 GHz.

To further improve the matching, the transmission line may to be split. We use the tool “Interconnect parameters” (Fig. 7), extend the cut-off frequency to 6 GHz, and choose the interconnect model and associated dimensions as close as the board used for DPI experiments.

Figure 4: The DPI injection path includes a portion of PCB and a 1-nF capacitance

Figure 5: Building a model for the DPI injection capacitance (Zin_DPI_1nF.sch)

Figure 6: Matching the injection path impedance with measurements (Zin_DPI_1nF.sch vs Zin_dpi_1nF.s)

Figure 7: Use of Interconnect Parameters to build a TLine model valid upto 6 GHz

Figure 8: Improved model to match measurements upto 6 GHz (Zin_DPI_1nF_xhf.sch)
Fig. 8 gives a xHF model of the 17-mm interconnect, using 3 R-L-C cells instead of one single cell. As may be seen in Fig. 9, the matching of the Z(f) injection path is improved upto 6 GHz.

### 3.2 Inductance model

A high frequency model of the 47µH inductance is proposed in Fig. 10. It can be seen that the main resonance (12 MHz) is well predicted, but the high frequency fluctuations (500, 800 MHz) are not handled by the proposed model (Fig. 11).

![Figure 10: Building a model for the 47µF discrete inductance (Zin_L47u.sch)](image)

**Figure 10: Building a model for the 47µF discrete inductance (Zin_L47u.sch)**

### 3.3 Ferrite model

Fig. 12 details the ferrite model used by F. Lafon [3][4] to match simulations with Z(f) measurements. In a first order approach, the ferrite may be considered as a simple resistance, ranging from 100 to 1000 Ω, with an average value close to 200 Ω. The measured ferrite impedance has a very unusual shape (Fig. 13), far from classical 20 dB/decade behaviors found in L or C components. The impedance ranges from 100 to 1000 Ω. The approach used by F. Lafon [4] is based on a network of coupled R/L circuits, an approach close to the skin-effect modeling described in IC-EMC manual “Appendix – EMC model library – Skin Effect Model”. More information about the ferrite model may also be found in the “Appendix – EMC model library – Inductor and Ferrite Model”.

**Figure 11: Matching the model with measurements for 47µF inductance (Zin_L47u.sch vs Zin_L47u.s50)**
3.3.1 IC Impedance measurements

The impedance measurement of the L4949 device is described in [1]. The L4949 is supplied either at 0 V or at nominal 12 V supply. A Vector network analyzer (VNA) is calibrated using short, open and 50 Ω loads prior to Z(f) measurements. More information may be also found in [5].

From the measurements reported in Fig. 15, we clearly see a dependence of the impedance versus the DC voltage at low frequencies (1-10 MHz), while the impedance is almost independent of the DC supply above 10 MHz. The explanation may be a dominant contribution of junction-based bias-dependent capacitance (1-10 MHz) and passive bias-independent L,C at high frequencies.
4 DPI modeling

4.1 DPI measurements

The immunity criterion is observed at the output of the regulator. The \( V_{out} \) drift larger than +/- 200 mV is considered as a fault. The voltage monitoring is performed by an oscilloscope, using a voltage mask at 4.8-5.2 V. Fig. 16 illustrates the case of a 100 MHz RFI at 12.9 dBm incident power. The RFI superimposed to the L4949 input \( V_{CC} \) (12 V) appears in an attenuated and distorted form on the \( V_{out} \) pin, with a DC shift and a voltage lower than 4.8 V.

![Figure 16: Example of fault: the output voltage (5.0V nominal) decreases down to 4.8 V (RFI at 100 MHz).](image)

4.2 A very simple DPI Model – Model A

The regulating device is firstly considered as a resistor, with a value adjusted to obtain a nominal output voltage of 5V. The regulator model shown in Fig. 17 only consists of a simple resistor (88 \( \Omega \)), capacitor (27 pF) and the package inductors (1 nH). The DC supply of 12V and the RF injection system are added in a simplified way. The ferrite is assumed to be around 220 \( \Omega \), which correspond to the average module of \( Z(f) \). The loads are placed according to the board design.

![Fig 17: Simple model “A” (L4949_modelA.sch)](image)

The 10 uF capacitor is mandatory for the regulator stability, while the 220 \( \Omega \) serial resistance represents a resistive load.

The test point is the output of the regulator, which is monitored using an active probe, with a negligible parasitic capacitance (4.7 pF) as compared to the 10 uF capacitor.

We configure the RFI in automatic mode, with a frequency range from 1 to 2000 MHz, a log scale, 10 points per decade, and a maximum power of 40 dBm. We also define a voltage failure above 5.2V and below 4.8 V. The set up is as follows:

- Click “Generate Spice”
- Launch WinSpice, run the 34 simulations in a row
- Click “Simulation Control file”, click “RFIcontrol_L4949_modelA.ctl”
- Click « Get power »
- Click “Add forward power”

In this situation, there is no non-linear device, so no rectification effect, and as we have placed a perfect decoupling of 10uF, no susceptibility criteria is matched for the whole frequency bandwidth (Fig. 19).
4.3 A less simple DPI Model – Model B

Accurate models of discrete components are added in model B shown in Fig. 20. The regulator itself is now composed of a resistance and a bypass capacitance which accounts for the emitter/collector physical capacitance on-chip, and provokes a significant path for the interference at high frequencies.

4.4 A DPI Model including non-linear functionality – Model C

From the time-domain measurements, we observe a clear negative DC shift at low frequencies due to RFI. A proposed solution consists in using the “B-element” which enables to describe non-linear equations.
Fig 22: The non-linear “B-element” in Winspice, with two predefined inputs

General form:
BXXXXXX N+ N- V=EXPR
BXXXXXX N+ N- I=EXPR
EXXXXXX N+ N- VALUE=EXPR
FXXXXXX N+ N- VALUE=EXPR

Examples:
B1 0 1 I=cos(v(1))+sin(v(2))
B1 0 1 V=ln(cos(log(v(1,2)))-v(3)^-v(1))
B1 3 4 I=17
B1 3 4 V=exp(pi*i(vdd))

N+ is the positive node, and N- is the negative node. If I is given then the device is a current source, and if V is given the device is a voltage source. In IC-EMC, the default operation is the multiplication of V(%1) and V(%2). The “%1” and “%2” variables represent the node number connected to port 1 and port 2.

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As illustrated in Fig. 24, the nominal output voltage Vout is 5 V, which is Vin- 7 V. Vin-12 V is the AC part of Vin (the RFI). It is squared to obtain a positive offset. The Low-Pass Filter (LPF) attenuates its effect above 100 MHz. k is a tuning factor.

Using Winspice coding language, the formulation is implemented as follows:

Fig 23: Properties of non-linear “B-element” in IC-EMC. Vout is the sum of Vin with a negative DC shift, with a negative offset (L4949_modelC.sch)

Fig 24: Macro-model principles (L4949_modelC.sch)
The simulation shown Fig. 25 features a good match with the measurement, for k fixed to -0.25. As stated in [1], the non-linear B-element handles the “in-band” mode. In other words, the L4949 really acts as a regulator up to 50 MHz. From 1 to 50 MHz, Vout is controlled by the negative feedback circuit and the L4949 is very sensitive to RFI. The non-linear expression combined with a low-pass filter is an efficient approach to reproduce the “in-band” mode.

References